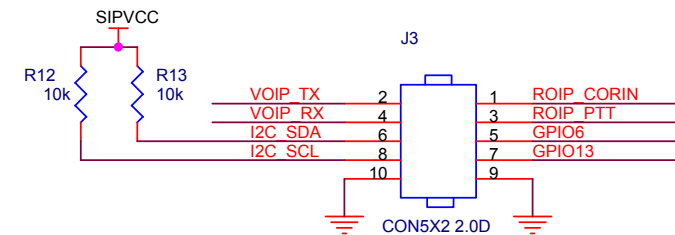
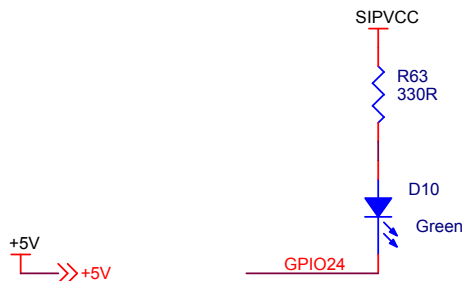
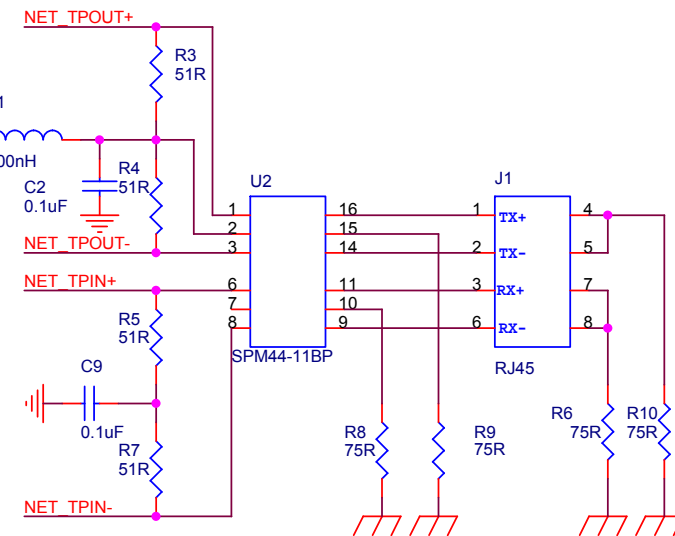
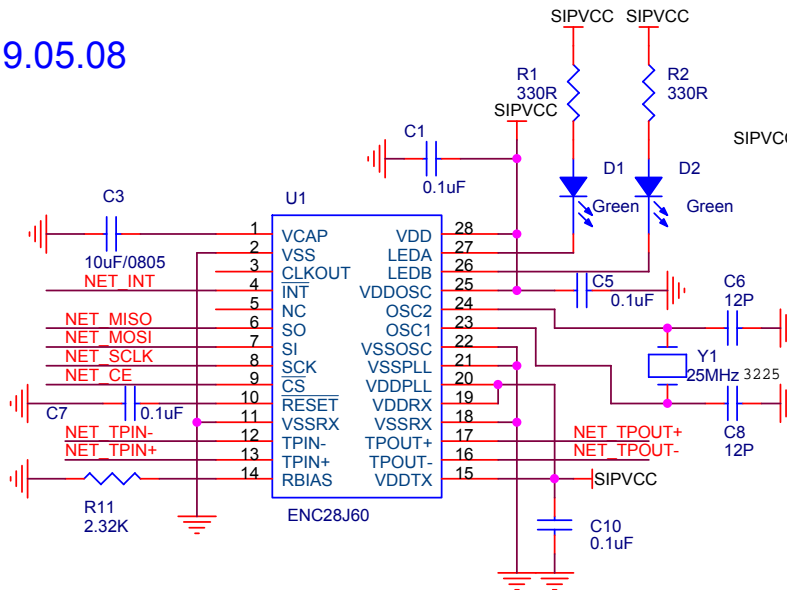
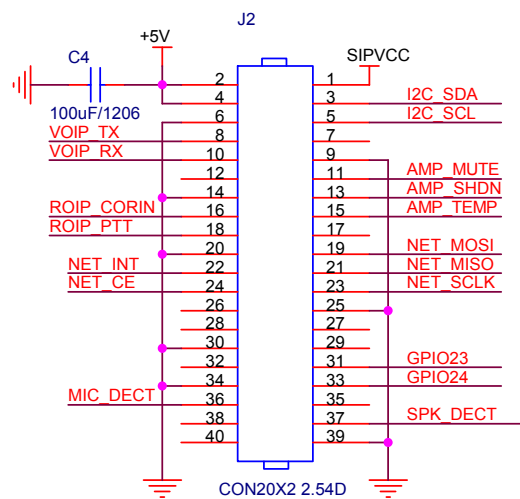


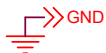
工令: JS203-16-B01_01

電路/Layout: 范姜德 / 彭萬明 2019.05.08

版本: v1.0



SPK_DECT << SPK_DECT
MIC_DECT << MIC_DECT
I2C_SDA << I2C_SDA
I2C_SCLK << I2C_SCLK
AMP_TEMP << AMP_TEMP
AMP_MUTE << AMP_MUTE
AMP_SHDN << AMP_SHDN

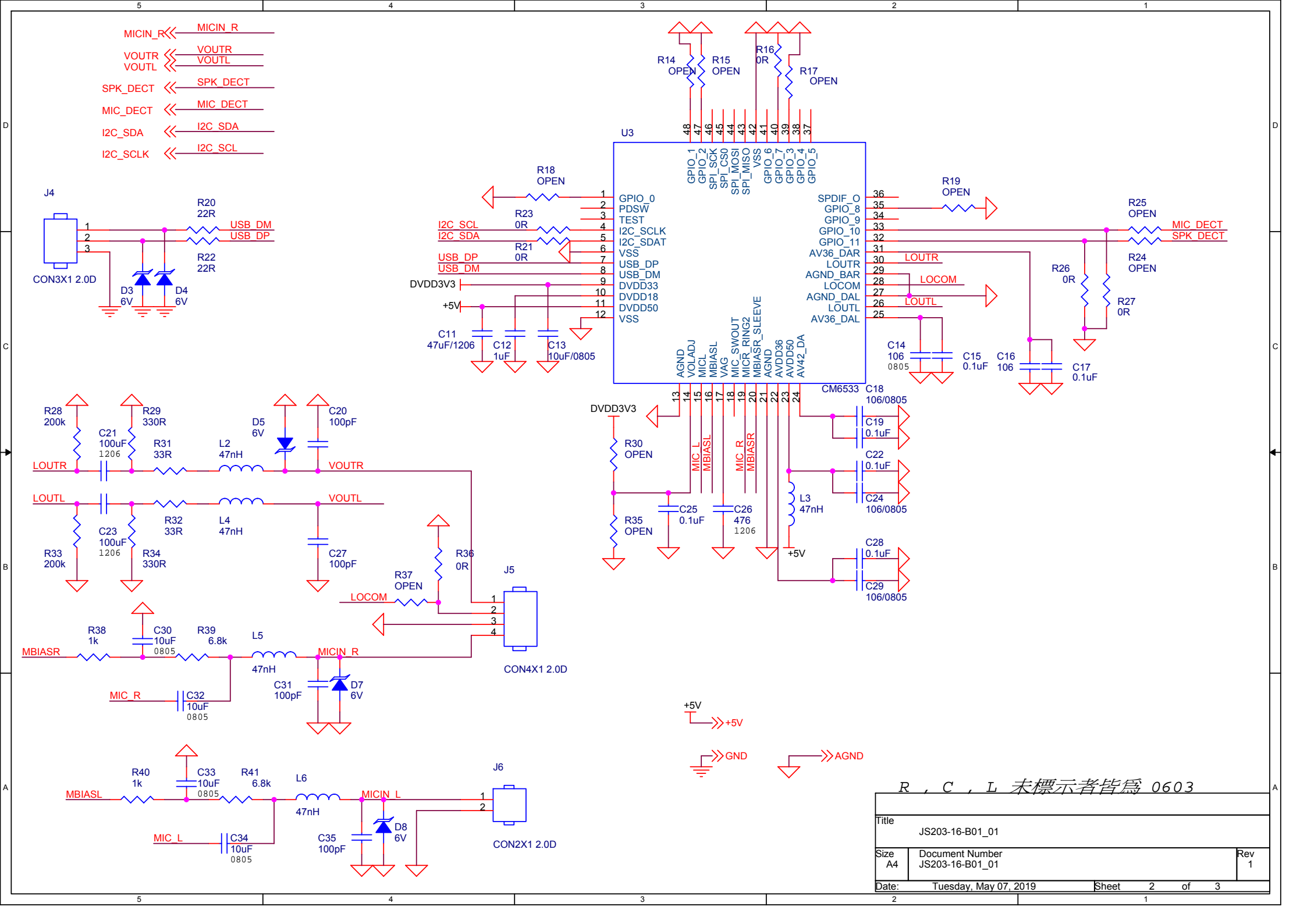


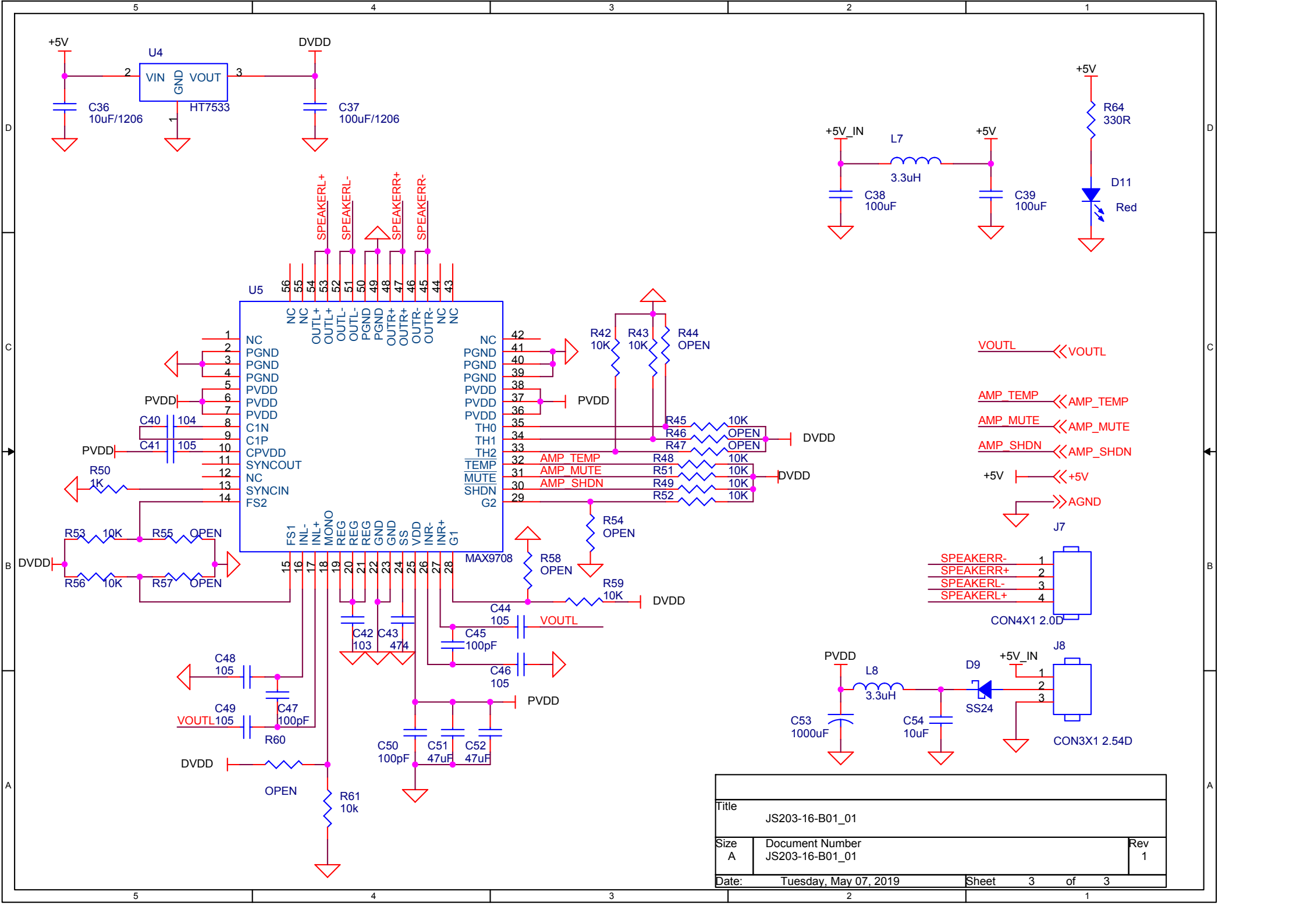
Kevin Harry Keith

請會簽第1.4頁

R , C , L 未標示者皆為 0603

Title JS203-16-B01_01		
Size A4	Document Number JS203-16-B01_01	Rev 1
Date: Tuesday, May 07, 2019	Sheet 1	of 3

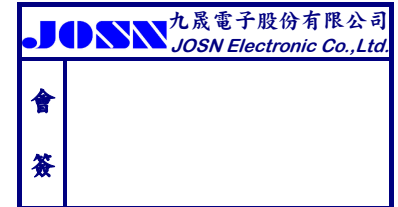




65.0mm

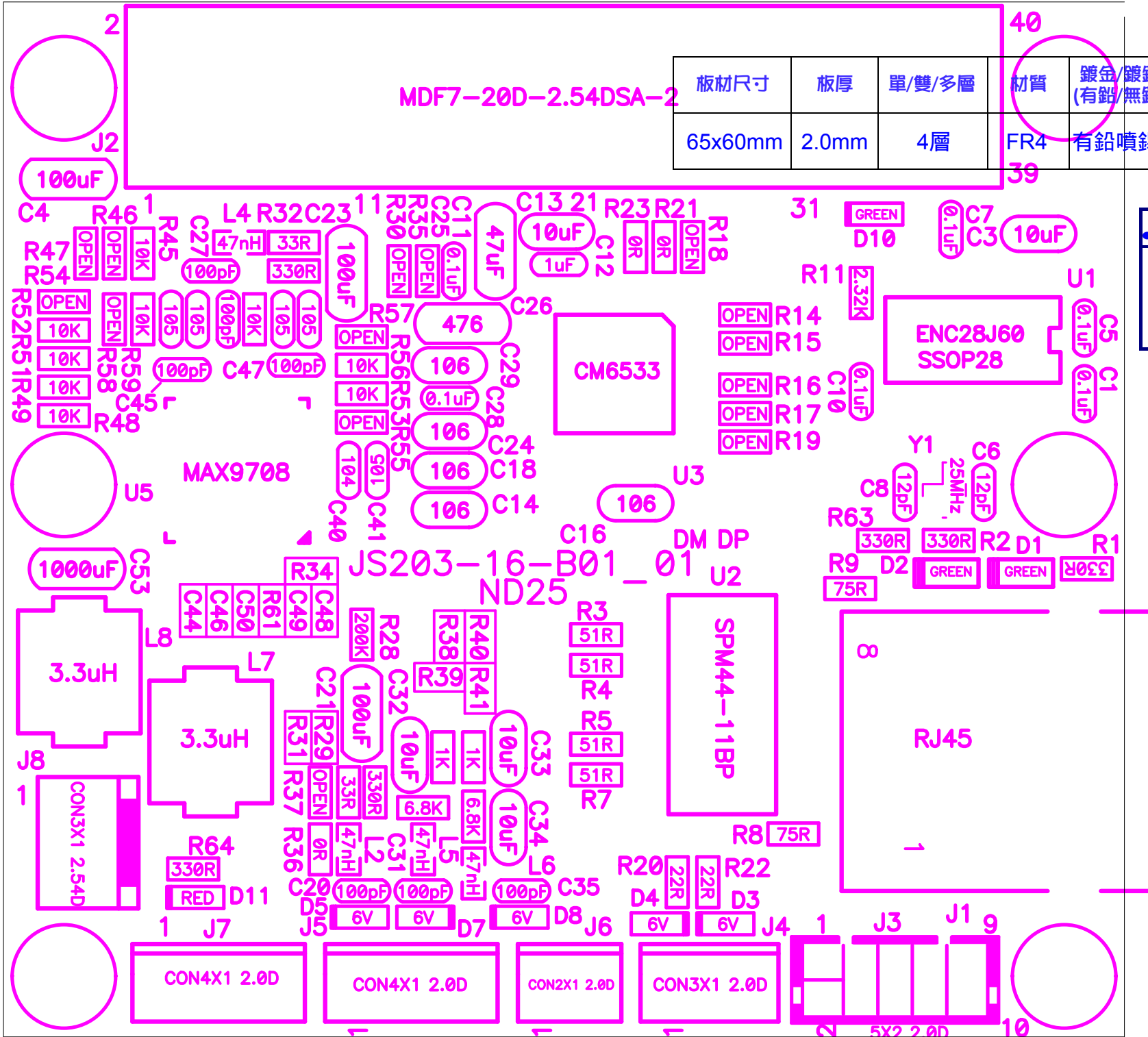
MDF7-20D-2.54DSA-2

板材尺寸	板厚	單/雙/多層	材質	鍍金/鍍錫 (有鉛/無鉛)	單片/連片	顏色	數量	其它
65x60mm	2.0mm	4層	FR4	有鉛噴錫	單片	綠色	20	



Harry Keith

60.0mm



mm0.20

mm0.00

R13 10K
R12 10K

R25 R24
OPEN OPEN
R27 R26
0R 0R
0.1uF
C17

C22 0.1uF
L3 47nH
C19 0.1uF
C15 0.1uF

R33 200K
C52 47uF
C51 47uF
R60 OPEN
1K
R50 103
474
C42 R43
10K 10K
OPEN
R44

R6 75R

L1 100nH
0.1uF
C2

C9 0.1uF

R10 75R

R62 0R

C30 10uF
JS203-16-B01_01
ND25

C36 10uF
C39 100uF
C38 100uF
C37 100uF
U4 HT7533
C54 10uF
SS24
D9

60.0mm

mm0.20

R13
R12

R33

C52

C51

R25 R24

C22

R60

C43

R42

R27

R26

L3

C19

R50

C42

R43

R44

C17

C15

R44

C37

R6

L1

C2

C36

U4

C9

C39

C38

C54

R10

C30

R62

JS203-16-B01_01
ND25

D9

mm0.00

